

Polyphenylene sulfide

Fortron 4665B6 offers a high Comparative Tracking Index (CTI) for application requiring resistance to high voltage. The product exhibits good heat and chemical resistance as well as good electrical properties. This grade is also inherently flame-retardant. Due to the balance of mineral and glass fibers the warpage is very low. Applications include electronic components (i.e. lamp sockets, housings and position frames).

Product information

1 Toddot Information			
Resin Identification	PPS-(GF+MD)6 5		ISO 1043
Part Marking Code	>PPS-(GF+MD)6	5<	ISO 11469
Rheological properties			
Moulding shrinkage, parallel	0.2	%	ISO 294-4, 2577
Moulding shrinkage, normal	0.6	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	17300	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	120	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.2	%	ISO 527-1/-2
Flexural modulus	16000	MPa	ISO 178
Flexural strength	180	MPa	ISO 178
Compressive strength	200	MPa	ISO 604
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30°C		kJ/m²	ISO 179/1eA
Izod notched impact strength, 23°C		kJ/m²	ISO 180/1A
Izod notched impact strength, -30 °C		kJ/m²	ISO 180/1A
Hardness, Rockwell, M-scale	100		ISO 2039-2
Poisson's ratio	0.33 ^[C]		
[C]: Calculated			
Thermal properties			
Melting temperature, 10°C/min	280	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	90	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	270	°C	ISO 75-1/-2
Temperature of deflection under load, 8 MPa	215	°C	ISO 75-1/-2
Coefficient of linear thermal expansion	20	E-6/K	ISO 11359-1/-2
(CLTE), parallel			
Coefficient of linear thermal expansion (CLTE),	25	E-6/K	ISO 11359-1/-2
normal			
Thermal conductivity, flow		W/(m K)	ISO 22007-2
Thermal conductivity, crossflow		W/(m K)	ISO 22007-2
Thermal conductivity, through plane	0.9	W/(m K)	ISO 22007-2



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Flammability Burning Behav. at 1.5mm nom. thickn. Thickness tested Burning Behav. at thickness h Thickness tested	1.5	class mm class mm	IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10 IEC 60695-11-10
Electrical properties			
Relative permittivity, 1MHz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index	>1E13 >1E15	E-4 Ohm.m Ohm kV/mm	IEC 62631-2-1 IEC 62631-2-1 IEC 62631-3-1 IEC 62631-3-2 IEC 60243-1 IEC 60112
Physical/Other properties			
Water absorption, 2mm Density	0.02 2030	% kg/m³	Sim. to ISO 62 ISO 1183
Injection			
Drying Recommended Drying Temperature Drying Time, Dehumidified Dryer Processing Moisture Content Melt Temperature Optimum Min. melt temperature Max. melt temperature Screw tangential speed Mold Temperature Optimum Min. mould temperature Max. mould temperature Hold pressure range Back pressure Ejection temperature	yes 130 2 - 4 ≤0.02 330 310 340 0.2 - 0.3 150 140 160 30 - 70 3 223	h % °C °C °C m/s °C °C MPa MPa	

Characteristics

Additives

Release agent

Additional information

Injection molding

Preprocessing

Predrying in a dehumidified air dryer at 130 - 140 degC/3-4 hours is recommended.

Processing

On injection molding machines with 15-25 D long three-section screws, as are usual in the trade, the FORTRON is processable. A shut-off nozzle is preferred to

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a free-flow nozzle.

Melt temperature 320-340 degC Mold wall temperature at least 140 degC

A medium injection rate is normally preferred. All mold cavities must be effectively vented.

Postprocessing

Tool temperature of at least 135 degC is recommended for parts to achieve maximum crystallizable potential.

Processing Notes

Pre-Drying

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be = - 30° C. The time between drying and processing should be as short as possible.

Storage

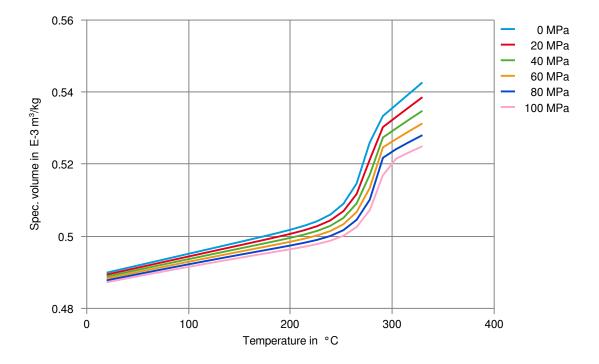
For subsequent storage the material should be stored dry in the dryer until processed (<= 60 h).

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Specific volume-temperature (pvT)



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